

Table 1:

#	Spec No.	Description	Spec Name UM	33MHz Min	33MHz Max
1	1	Cycle period	tcyc	30	
2	2,3	Clock pulse width	tcl,tch	15	
3	5A	EXTAL to Clock delay	tcd	2	11
4	6	Clock high to FC, address valid	tchfcadv	0	27
5	7	Clock high to Address, Data Hi-z	tchadz	-	25
6	8	Clock high to Address, FC invalid (Minimum)	tchafi	0	-
7	9	Clock high to AS, DS asserted	tchsl	3	15
8	11	Address, FC Valid to AS, DS Assert (read) AS assert (Write)	tafcvsl	8	-
9	12	Clock low to AS, DS negate	tcsln	-	15
10	13	AS, DS Negated to Address FC Invalid	tshafi	8	-
11	14	AS (and DS read) width asserted	tsl	60	-
12	14A	DS width asserted, write	tdsl	30	-
13	15	AS, DS width negate	tsh	30	-
14	16	Clock high to Control Bus Hi-z	tchca	-	25
15	17	AS, DS Negated to R/W Invalid	tshrh	8	-
16	18	Clock high to R/W hi	tchrh	-	15

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#	Spec No.	Description	Spec Name UM	33MHz Min	33MHz Max
17	20	Clock high to R/W Io	tchrl	-	15
18	20A	AS Asserted to R/W Low (Write)	tasrv	-	7
19	21	Address FC Valid to R/W Low (Write)	tafcvrl	8	-
20	22	R/W low to DS assert (write)	trasa		
21	23	Clock low to data valid	tcldo	-	15
22	25	AS, DS Negated to Data-out invalid	tcldo	-	15
23	26	Data-out valid to DS Asserted (Write)	tdosl	8	-
24	27	Data in to Clock low	tdicl	4	-
25	28	AS, DS negate to DTACK negate	tshdah	0	65
26	29	AS, DS Negated to Data In invalid	tshdii	0	-
27	30	AS, DS negated to BERR negated	tshbeh	0	-
28	31	DTACK assert to Data-In valid	tdaldi	-	25
29	32	HALT,RESET in transition time	trhr, thrf	-	150
30	33	Clock high to BG assert	tchgl	-	15
31	34	Clock high to BG negate	tchgh	-	15
32	35	BR assert to BG assert	tbrlgl	2.5 clks	4.5 clks
33	36	BR negate to BG negate	tbrhgh	1.5 clks	2.5 clks

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34	37	BGACK assert to BG negate	tgalgh	2.5 clks	4.5 clks
35	37A	BGACK assert to BR negate	tgalbrh	10 ns	1.5 clks
36	38	BG assert to Addr, Data, etc. hi-z	tglz	-	25
37	39	BG width negate	tgh	1.5 clks	-
38	40	BGACK assert to Address valid	tgalav	15	-
39	41	BGACK assert to AS assert	tgalasa	-	20
40	44	AS, DS negate to AVEC negate	tshvph	0	25
41	46	BGACK width low	tgal	1.5 clks	1.5 clks
42	47	Async input setup time	tasi	7	-
43	48	BERR assert to DTACK assert	tbeldal	7	-
44	53	Data-out hold from clk high	tchdoi	0	-
45	55	R/W assert to Data bus impedance change	trlbbd	0	-
46	56	HALT/RESET pulse width	thrpw	10 clks	-
47	57	BGACK negate to AS, DS, RW driven	tgasd	1.5 clks	-
48	57A	BGACK negate to FC	tgaofd	1 clk	-
49	58	BR negate to AS, DS, RW driven	trhsd	1.5 clks	-
50	58A	BR negate to FC	trhfd	1 clk	

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51	60	Clock high to BCLR assert	tchbca	-	15
52	61	Clock high to BCLRO hi-z	tchbcn	-	15
53	62	Clock low to RMC assert	tcrlml	-	17
54	63	Clock high to RMC negate	tchrmh	-	17
55	64	RMC negate to BG assert	trmhgl	-	15
56	80	DREQ asynchronous set up time	treqasi	10	-
57	81	DREQ width low	treql	2 clks	-
58	82	DREQ low to BR low	treqlbrl	-	2 clks
59	83	Clock high to BR low	tchbrl	-	15
60	84	Clock high to BR hi-z	tchbrz	-	15
61	85	BGACK low to BR hi-z	tbklbrz	15	-
62	86	Clock high to BGACK low	tchbkl	-	15
63	87	AS and BGACK high to BGACK low	tabhbkl	1.5 clks	2.5 clks + 20 ns
64	88	BG low to BGACK low	tbglbkl	1.5 clks	2.5 clks + 20 ns
65	89	BR hi-z to BG high	trhbgh	0	-

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#	Spec No.	Description	Spec Name UM	33MHz Min	33MHz Max
66	90	Clock on which BGACK low to clock on which AS low	tlbklal	2 clks	2 clks
67	91	Clock high to BGACK high	tchbkh	-	15
68	92	Clock low to BGACK hi-z	tlbkz	-	10
69	93	Clock high to DACK low	tchackl	-	15
70	94	Clock low to DACK high	tlackh	-	15
71	95	Clock high to DONE low (output)	tchdnl	-	15
72	96	Clock low to DONE hi-z	tcldnz	-	15
73	97	DONE input low to clock high	tdnlteh	10	-
74	100	RW valid to DS low	trwvdsi	0	-
75	101	DS low to Data-in valid	tdsldiv	-	15
76	102	DTACK low to Data in hold time	tdklth	0	-
77	103	AS valid to DS low	tasvdsi	0	-
78	104	DTACK low to AS, DS high	tdklsh	0	-
79	105	DS high to DTACK high	tdshdkh	-	25
80	106	DS inactive to AS inactive	tdsiasl	0	-
81	107	DS high to RW high	tdshrwh	0	-
82	108	DS high to data hi-z	tdshdz	-	25

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#	Spec No.	Description	Spec Name UM	33MHz Min	33MHz Max
83	108A	DS high to data out hold time	tdshdh	0	-
84	109A	Data out valid to DTACK low	tdovdcl	10	-
85	110	Address valid to AS low	tavasl	8	-
86	111	AS low to clock high	taslch	15	-
87	112	Clock low to AS high	tclash	-	25
88	113	AS high to address hold time on write	tashah	0	-
89	114	AS inactive time	tash	1 clk	-
90	115	UDS/LDS low to clock high	tslch	21	-
91	116	Clock low to UDS/LDS high	tcslsh	-	20
92	117	RW valid to clock high	trwvch	15	-
93	118	Clock high to RW high	tchrwh	-	20
94	119	AS low to IAC high	taslah	-	21
95	120	AS high to IAC low	tashal	-	21
96	121	AS low to DTACK low (0 wait states)	tasldtl	-	25
97	122	Clock low to DTACK low (1 wait state)	tcldtl	-	15
98	123	AS high to DTACK high	tashdth	-	20
99	124	DTACK high to DTACK hi-z	tdthdtz	-	10



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#	Spec No.	Description	Spec Name UM	33MHz Min	33MHz Max
100	125	Clock high to data out valid	tchdov	-	15
101	126	AS high to data hi-z	tashdz	-	25
102	127	AS high to data out hold time	tashdoi	0	-
103	128	AS high to address hold time on read	tashai	0	-
104	129	UDS/LDS inactive time	tsh	1 clk	-
105	130	Data in valid to clock low	tcldiv	15	-
106	131	Clock low to data in hold time	tcldih	10	-
107	140	Clock high to IAC high	tchiah	-	21
108	141	Clock low to IAC low	tcial		21
109	142	Clock high to DTACK low	tchdtl	-	25
110	143	Clock low to DTACK high	tcldth	-	22
111	144	Clock high to data out valid	tchdov	-	15
112	145	AS high to data out hold time	tashdoh	0	-
113	150	Clock high to CS, IACK low	tchcsiakl	0	20
114	151	Clock low to CS, IACK high	tcclsiakh	0	20
115	152	CS width negated	tcsh	30	-
116	153	Clock high to DTACK low (0 wait states)	tchdtkl	-	25



Table 1:

#	Spec No.	Description	Spec Name UM	33MHz Min	33MHz Max
117	154	Clock low to DTACK low (1-6 wait states)	tcldtkh	-	15
118	155	Clock low to DTACK high	tcldtkh	-	20
119	156	Clock high to BERR low	tchberl	-	20
120	157	Clock low to BERR hi-z	tcberh	-	20
121	158	DTACK high to DTACK hi-z	tdtkhdtkz	-	10
122	160	AS low to CS low	taslcsl	-	16
123	161	AS high to CS high	tashcsh	-	16
124	162	Address valid to AS low	tavasl	8	-
125	163	RW valid to AS low	trwvasl	8	-
126	164	AS negated to address hold time	tashai	0	-
127	165	AS low to DTACK low (0 wait states)	tasldtkl	-	25
128	167	AS high to DTACK high	tashdtkh	-	18
129	168	AS low to BERR low	taslberl	-	18
130	169	AS high to BERR hi-z	tashberh	-	18
131	171	Input data hold time from S6 low	tidhcl	5	-
132	172	CS negated to data out invalid (write)	tcsndoi	7	-
133	173	Address, FC valid to CS asserted	tafvcsa	15	-



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#	Spec No.	Description	Spec Name UM	33MHz Min	33MHz Max
134	174	CS negated to address, FC invalid	tcsnafi	12	-
135	175	CS low time (0 wait states)	tcslt	60	-
136	176	CS negate to RW invalid	tcsnrwi	7	-
137	177	CS assert to RW low (Write)	tcsarwl	-	8
138	178	CS negate to data in invalid	tcsndii	0	-
139	180	Input data setup time	tdsu	14	-
140	181	input data hold time	tdh	-	19
141	182	Clock high to data out valid	tchdov	-	20
142	190	Interrupt Pulse Width low IRQ	tipw	28	-
143	191	Minimum time between active edges	taemt	3 clks	-
144	200	Timer input capture pulse width	tipw	28	-
145	201	TIN clock low pulse width	ticlt	28	-
146	202	TIN clock high pulse width and input capture high pulse width	ticht	2 clks	-
147	203	TIN clock cycle time	tcyc	3 clks	-
148	204	Clock high to TOUT valid	tchto	-	24
149	205	FRZ input setup time (to clock high)	tfrzsu	14	-
150	206	FRZ input setup time (from clock high)	tfrzht	7	-

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#	Spec No.	Description	Spec Name UM	33MHz Min	33MHz Max
151	250	SPCLK clock output period		4 clks	64 clks
152	251	SPCLK clock output rise/fall time		0	6
153	252	Delay from SPCLK to transmit		0	20
154	253	SCP receive setup time		20	-
155	254	SCP receive hold time		6	-
156	260	L1CLK (IDL Clock) frequency		-	13.3 MHz
157	261	L1CLK width low		28	-
158	262	L1CLK width high		P+10	-
159	263	L1TXD, L1RQ, SDS1-SDS2 rise/fall time		-	12
160	264	L1SY1 (sync) setup time (to L1CLK falling edge)		15	-
161	265	L1SY1 (sync) hold time (to L1CLK falling edge)		28	-
162	266	L1SY1 (sync) inactive before 4th L1CLK		0	-
163	267	L1TXD active delay (from L1CLK falling edge)		0	40
164	268	L1TXD to hi-z (from L1CLK rising edge)		0	26
165	269	L1RXD setup time (to L1CLK falling edge)		26	-
166	270	L1RXD hold time (from L1CLK falling edge)		26	-
167	271	Time between successive IDL syncs		20 L1CLKS	-

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#	Spec No.	Description	Spec Name UM	33MHz Min	33MHz Max
168	272	L1RQ valid before falling edge of L1SY1		1 L1CLKS	-
169	273	L1GR setup time (to L1SY1 falling edge)		26	-
170	274	L1GR hold time (from L1SY1 falling edge)		26	-
171	275	SDS1-SDS2 active delay from L1CLK rising edge		7	40
172	276	SDS1-SDS2 inactive delay from L1CLK falling edge		7	40
173	280	L1CLK clock period normal mode		1800	2100
174	281	L1CLK width low/high normal mode		840	1450
175	282	L1CLK rise/fall time Normal mode		-	-
176	280	L1CLK clock period MUX mode		150	-
177	281	L1CLK width low/high MUX mode		55	-
178	281A	L1CLK width high MUX mode		P+10	-
179	282	L1CLK rise/fall time MUX mode		-	-
180	283	L1SY1 sync setup time to L1CLK falling edge		15	-
181	284	L1SY1 sync hold time (from L1CLK falling edge)		26	-
182	285	L1TXD active delay (from L1CLK rising edge)		0	55
183	286	L1TXD active delay (from L1SY1 rising edge)		0	55
184	287	L1RXD Setup time to L1CLK rising edge		14	-

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#	Spec No.	Description	Spec Name UM	33MHz Min	33MHz Max
185	288	L1RXD hold time from L1CLK rising edge		26	-
186	289	Time between successive L1SY1		64 L1CLK 192 L1CLK	-
187	290	SDS1-SDS2 active delay from L1CLK rising edge		7	45
188	291	SDS1-SDS2 active delay from L1SY1 rising edge		7	45
189	292	SDS1-SDS2 inactive delay from L1CLK falling edge		7	45
190	293	GCIDCL (GCI data clock) active delay		0	26
191	300	L1CLK (PCM clock) frequency		-	13.2 MHz
192	301	L1CLK width low		27	-
193	301A	L1CLK width high		P+10	-
194	302	L1SY0-L1SY1 setup time		0	-
195	303	L1SY0-L1SY1 hold time		20	-
196	304	L1SY0-L1SY1 width low		1 L1CLK	-
197	305	Time between successive sync signals		8 L1CLK	-
198	306	L1TXD data valid after L1CLK rising edge		0	40
199	307	L1TXD to hi-z (from L1CLK rising edge)		0	26
200	308	L1RXD setup time (to L1CLK falling edge)		11	-

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#	Spec No.	Description	Spec Name UM	33MHz Min	33MHz Max
201	309	L1RXD hold time (from L1CLK falling edge)		26	-
202	315	RCLK1 and TCLK1 frequency	Internal clk External clk	- -	11 MHz 13.2 MHz
203	316	RCLK1 and TCLK1 low	Internal clk External clk	35ns P+10	- -
204	316A	RCLK1 and TCLK1 high	Internal clk External clk	35 25	- -
205	317	RCLK1 and TCLK1 rise/fall time	Internal clk External clk	- -	11 -
206	318	RXD1 active delay from TCLK1 falling edge	Internal clk External clk	0 0	20 30
207	319	RTS1 active/inactive delay from TCLK1 falling edge	Internal clk External clk	0 0	20 50
208	320	CTS1 setup time to TCLK1 rising edge	Internal clk External clk	30 7	- -
209	321	RXD1 setup time to RCLK1 rising edge	Internal clk External clk	30 7	- -
210	322	RXD1 hold time from RCLK1 rising edge	Internal clk External clk	7 30	- -
211	323	CD1 setup time to RCLK1 rising edge	Internal clk External clk	30 7	- -